IEEE P802.3cw Task Force 27 Sept 2021 Interim Teleconference Meeting

Approved Meeting Minutes, Prepared by John D'Ambrosia

Meeting called to order at 10:02 am ET (all times ET) by John D'Ambrosia, who was chairing the meeting.

Chair noted that individuals should fill out IMAT information for attendance.

Presentation #1 Agenda and General Information

Presenter: John D'Ambrosia

URL: https://www.ieee802.org/3/cw/public/21 09/agenda 3cw 210927.pdf

The chair asked if there were any objections to the agenda. There were no other objections to anything on the agenda, and it was considered approved.

Minutes -

30 Aug - https://www.ieee802.org/3/cw/public/tf interim/21 0830/minutes 3cw 210830 unapproved.pdf

Chair asked if there were any corrections – there were note. Chair asked if there were any objections to approving the noted meeting minutes – there were none, and the minutes were considered approved.

Chair noted that the agenda deck had been sent out, and requested that individuals review the following IEEE SA policies prior to the interim meeting –

- IEEE SA Participation Policy
- IEEE SA Copyright Policy
- IEEE SA Patent Policy

Chair asked if anyone needed any of these policies reviewed in-depth. There were no requests.

Chair presented the second slide (See Slide #23) of the IEEE SA Participation Policy slides. Chair noted — "Participants in the IEEE-SA "individual process" shall act independently of others, including employers. By participating in standards activities using the "individual process", you are deemed to accept these requirements; if you are unable to satisfy these requirements then you shall immediately cease any participation."

Chair presented the third slide (See Slide #28) of the IEEE SA Patent Policy slides. Chair did call for Potentially Essential Patents, and no one came forward.

Chair presented the second slide (See Slide #33) of the IEEE SA Copyright Policy slides. Chair noted – "By participating in this activity, you agree to comply with the IEEE Code of Ethics, all applicable laws, and all IEEE policies and procedures including, but not limited to, the IEEE SA Copyright Policy."

Chair reminded TF about 3<sup>rd</sup> Task Force Review. See Slide #4

Presentation #2 802.3cw D1.2 missing baselines and TBDs

Presenter Tom Issenhuth

URL https://www.ieee802.org/3/cw/public/21 09/issenhuth 3cw 01 210927.pdf

## Discussion of the noted TBDs

- During discussion of 116.4 Table 116-6 Mike Sluyski agreed to comment on this topic and provide proposed values.
- Tom Issenhuth will reach out for individuals involved with coherent CMIS for list of controls and status bits that are needed. It was suggested that a table should be presented for consideration by the Task Force.
- For Laser Frequency Noise Mask comment needed to move away from a single value in Table 156-6 and point to Table 156-12 for this table entry

- Eric Maniloff to review draft for stragglers related to removal of unamplified applications and submit comments against D1.2 as appropriate.
- For Average Output power at TP3 (min), it was suggested that the value of -12 should be used.
- There was discussion about the Interferometric crosstalk at TP3 (max) in Table 156-8.. It was suggested that this is more a factor for ROADM systems and may not be applicable and it might be appropriate to remove. Offline discussion suggested.
- Ali Ghiasi commented he might be able to bring in suggested values for Adjacent Channel Isolation in Table 156-9 and submit comment as appropriate.
- Tom Issenhuth to reach out to Fabio Pittala / Bernd Nebendahl about Page 6 to see about proposed text. It was also suggested to look at the latest draft of 400ZR sent by liaison from the OIF.

Chair reviewed liaisons assigned to the Task Force. Chair noted that he had discussed the ITU-T related liaisons with individuals who participate in the ITU-T, and it was suggested to wait until the Nov plenary to respond, as the groups that authored the liaisons won't be meeting until December 2021. Chair also noted that he had received no responses to his email to the reflector regarding the OIF liaison and was proposing to wait until the Nov Plenary as well.

Tom Issenhuth chaired meeting at 10:56am, so Mr. D'Ambrosia could present the following presentation.

Presentation #3 IEEE P802.3cw Timeline Discussion

Presenter John D'Ambrosia

URL https://www.ieee802.org/3/cw/public/21 09/dambrosia 3cw 01 210927.pdf

John D'Ambrosia resumed chairing the meeting @ 11:13am.

Motion #1 Move to adopt project timeline specified on Slide #5 of dambrosia\_3cw\_01\_210927.pdf for

IEEE P802.3cw

Moved by Tom Issenhuth
Second by Steve Trowbridge

Technical >=75%

Results All (y/n/a) Approved by unanimous consent

The chair noted future meetings were to be announced. See Slide #5.

Chair noted that Greg LeCheminant had offered to provide the group with a tutorial on EVM. Chair noted he would be working with Greg and Tom Issenhuth to re-schedule, as there was a conflict on the 07 Oct meeting.

Meeting adjourned at 11:19 am

## Attendees (per IMAT)

tomofuji, hiroaki

FUJITSU

| Name                  | Affiliation   | Employer  |
|-----------------------|---|---|
| bordogna, mark        | Intel Corporation   | Intel Corporation   |
| Boyer, Rich           | Aptiv Signal and Power Solutions                            | Aptiv - Signal and Power Solutions                                |
| Brooks, Paul          | Viavi Solutions   | Viavi solutions GmbH  |
| Choudhury, Golam      | OFS   | OFS   |
| D'Ambrosia, John      | Futurewei Technologies, U.S. Subsidiary of Huawei           | Futurewei Technologies  |
| Geng, Limin           | Huawei Technologies Co., Ltd                                | Huawei Technologies Co., Ltd                                      |
| Ghiasi, Ali           | Ghiasi Quantum LLC, Marvell                                 | Ghiasi Quantum LLC  |
| Gorshe, Steven Scott  | Microchip Technology, Inc.                                  | Microchip Technology, Inc.  |
| Haasz, Jodi           | IEEE Standards Association (IEEE-SA)                        | IEEE - Institute of Electrical and Electronics<br>Engineers       |
| He, Xiang             | Huawei Technologies Co., Ltd                                | Huawei Technologies Co., Ltd                                      |
| Huber, Thomas         | Nokia   | Nokia   |
| Ingham, Jonathan      | Huawei Technologies Canada; Huawei<br>Technologies Co., Ltd | Huawei Technologies Co., Ltd                                      |
| Isono, Hideki         | Fujitsu Optical Components Limited                          | Fujitsu Optical Components Limited                                |
| Issenhuth, Tom        | Huawei Technologies Co., Ltd                                | Issenhuth Consulting, LLC   |
| Jackson, Kenneth      | Sumitomo Electric Industries, LTD                           | Sumitomo Electric Device Innovations, USA                         |
| Jonsson, Ragnar       | Marvell   | Marvell Semiconductor, Inc.                                       |
| Klempa, Michael       | Amphenol Corporation  | University of New Hampshire InterOperability Laboratory (UNH-IOL) |
| Koeppendoerfer, Erwin | LEONI   | LEONI Kabel GmbH  |
| Lewis, David          | Lumentum Inc.   | Lumentum Inc.   |
| Maki, Jeffery         | Juniper Networks, Inc.                                      | Juniper Networks, Inc.  |
| Maniloff, Eric        | Ciena Corporation   | Ciena Corporation   |
| Mueller, Thomas       | Rosenberger   | Rosenberger   |
| Nering, Raymond       | Cisco Systems, Inc.   | Cisco Systems, Inc.   |
| Nowell, Mark          | Cisco Systems, Inc.   | Cisco Systems, Inc.   |
| Ofelt, David          | Juniper Networks, Inc.                                      | Juniper Networks, Inc.  |
| Omori, Kumi           | NEC Corporation   | NEC Corporation   |
| Pandey, Sujan         | Huawei Technologies (Netherlands) B.V.                      | Huawei Technologies (Netherlands) B.V.                            |
| PARK, CHUL SOO        | Juniper Networks, Inc.                                      | Juniper Networks Inc.   |
| peng, semmy           | Huawei Technologies Co., Ltd                                |   |
| Pittala, Fabio        | Huawei Technologies Duesseldorf GmbH                        | Huawei Technologies Duesseldorf GmbH                              |
| Ren, Hao              | Huawei Technologies Co., Ltd                                | Huawei Technologies Co., Ltd                                      |
| Sambasivan, Sam       | AT&T  | AT&T  |
| SAWANO, Hiroshi       | OITDA   | OITDA (Optoelectronics Industry and                               |
| Cha Ciarra            | Fulltan Nationals Communications                            | Technology Development Association)                               |
| She, Qingya           | Fujitsu Network Communications                              | Fujitsu Network Communications                                    |
| Sluyski, MIke         | Cisco Systems, Inc.   | CLODALFOLINDRIES  |
| Sorbara, Massimo      | GLOBALFOUNDIRES   | GLOBALFOUNDRIES   |
| Stassar, Peter        | Huawei Technologies Co., Ltd                                | Huawei Technologies Co., Ltd                                      |
| SU, CHANGZHENG        | Huawei Technologies Co., Ltd                                | FULLITATION A DODATORIES LINAITED                                 |
| TAKAHARA, TOMOO       | FUJITSU LIMITED   | FUJITSU LABORATORIES LIMITED                                      |
| Theodoras, James      | HG Genuine  | HG Genuine  |

Tooyserkani, Pirooz Cisco Systems, Inc. Tracy, Nathan TE Connectivity

Trowbridge, Stephen Nokia

Wang, Xinyuan Huawei Technologies Co., Ltd

Williams, Tom Cisco Systems, Inc.
Withey, James Fluke Corporation
Young, James CommScope

Zhang, Bo Marvell Technology, Inc

Cisco Systems, Inc. TE Connectivity

Nokia

Huawei Technologies Co., Ltd

Cisco Systems, Inc. Fluke Corporation CommScope, Inc.

Marvell Technology, Inc